

**SLDV-THR 5.08/28/180FLF 3.2SN BK BX**

**Weidmüller Interface GmbH & Co. KG**  
 Klingenbergsstraße 26  
 D-32758 Detmold  
 Germany

[www.weidmueller.com](http://www.weidmueller.com)

**Product image**

High-temperature resistant, double level, laterally offset, male connector with flange or solder flange. 1.5 mm solder pin is suitable for reflow soldering. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded.

**General ordering data**

Version	PCB plug-in connector, male header, Flange / Solder flange, THT/THR solder connection, 5.08 mm, Number of poles: 28, 180°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<a href="#">1889200000</a>
Type	SLDV-THR 5.08/28/180FLF 3.2SN BK BX
GTIN (EAN)	4032248495504
Qty.	10 pc(s).
Product data	IEC: 400 V / 15 A UL: 300 V / 10 A
Packaging	Box

Creation date September 16, 2022 9:15:38 PM CEST

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## Technical data

## Dimensions and weights

Depth	23.67 mm	Depth (inches)	0.932 inch
Height	29.36 mm	Height (inches)	1.156 inch
Height of lowest version	26.16 mm	Width	81.28 mm
Width (inches)	3.2 inch	Net weight	24.1 g

## System specifications

Product family	OMNIMATE Signal - series BL/SL 5.08	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5.08 mm
Pitch in inches (P)	0.2 inch	Outgoing elbow	180°
Number of poles	28	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder eyelet hole diameter (D)	1.5 mm
Solder eyelet hole diameter tolerance (D)+ 0,1 mm		L1 in mm	66.04 mm
L1 in inches	2.6 inch	Number of rows	2
Pin series quantity	2	Touch-safe protection acc. to DIN VDE 57 106	finger-safe plugged/ back-of-hand-safe unplugged
Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged	Protection degree	IP20
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	10 N	Pulling force/pole, max.	7.5 N

## Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuSn
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, max.	100 °C
Temperature range, installation, max.	100 °C		

## Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	15 A
Rated current, max. number of poles (Tu=20°C)	10.5 A	Rated current, min. number of poles (Tu=40°C)	13 A
Rated current, max. number of poles (Tu=40°C)	9 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Short-time withstand current resistance	1 x 1s with 120 A

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**Technical data****Rated data acc. to CSA**

Institute (CSA)	Certificate No. (CSA)		
		200039-1121690	
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

**Packing**

Packaging	Box	VPE length	165 mm
VPE width	93 mm	VPE height	48 mm

**Classifications**

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01

**Important note**

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
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Notes	<ul style="list-style-type: none"> <li>Rated current related to rated cross-section &amp; min. No. of poles.</li> <li>Spacing between rows: see hole layout</li> <li>P on drawing = pitch</li> <li>Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li> <li>Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months</li> </ul>
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**Approvals**

Approvals	  
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ROHS	Conform
UL File Number Search	<a href="#">UL Website</a>
Certificate No. (UR)	E60693

**Technical data****Downloads**

Approval/Certificate/Document of Conformity	<a href="#">Declaration of the Manufacturer</a>
Engineering Data	<a href="#">CAD data – STEP</a>
Engineering Data	<a href="#">WSCAD</a>
Catalogues	<a href="#">Catalogues in PDF-format</a>
Brochures	<a href="#">FL DRIVES EN</a> <a href="#">MB DEVICE MANUF. EN</a> <a href="#">FL DRIVES DE</a> <a href="#">FL BUILDING SAFETY EN</a> <a href="#">FL APPL LED LIGHTING EN</a> <a href="#">FL INDUSTR.CONTROLS EN</a> <a href="#">FL MACHINE SAFETY EN</a> <a href="#">FL HEATING ELECTR EN</a> <a href="#">FL APPL_INVERTER EN</a> <a href="#">FL_BASE_STATION_EN</a> <a href="#">FL_ELEVATOR_EN</a> <a href="#">FL_POWER_SUPPLY_EN</a> <a href="#">FL_72H_SAMPLE_SER_EN</a> <a href="#">PO_OMNIMATE_EN</a> <a href="#">PO_OMNIMATE_EN</a>
White paper surface mount technology	<a href="#">Download Whitepaper</a>

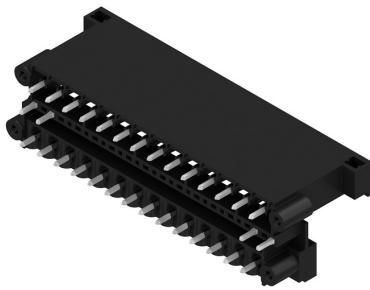
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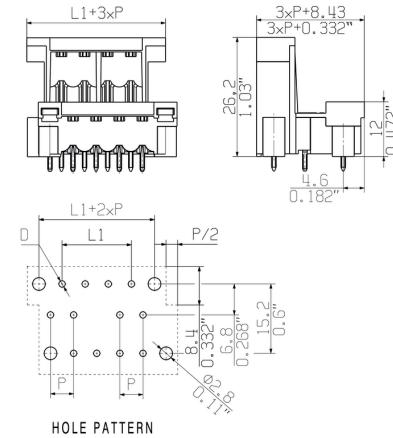
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# Drawings

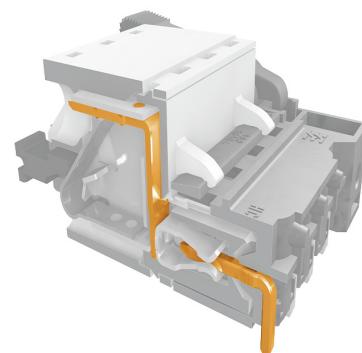
## Product image



## Dimensional drawing



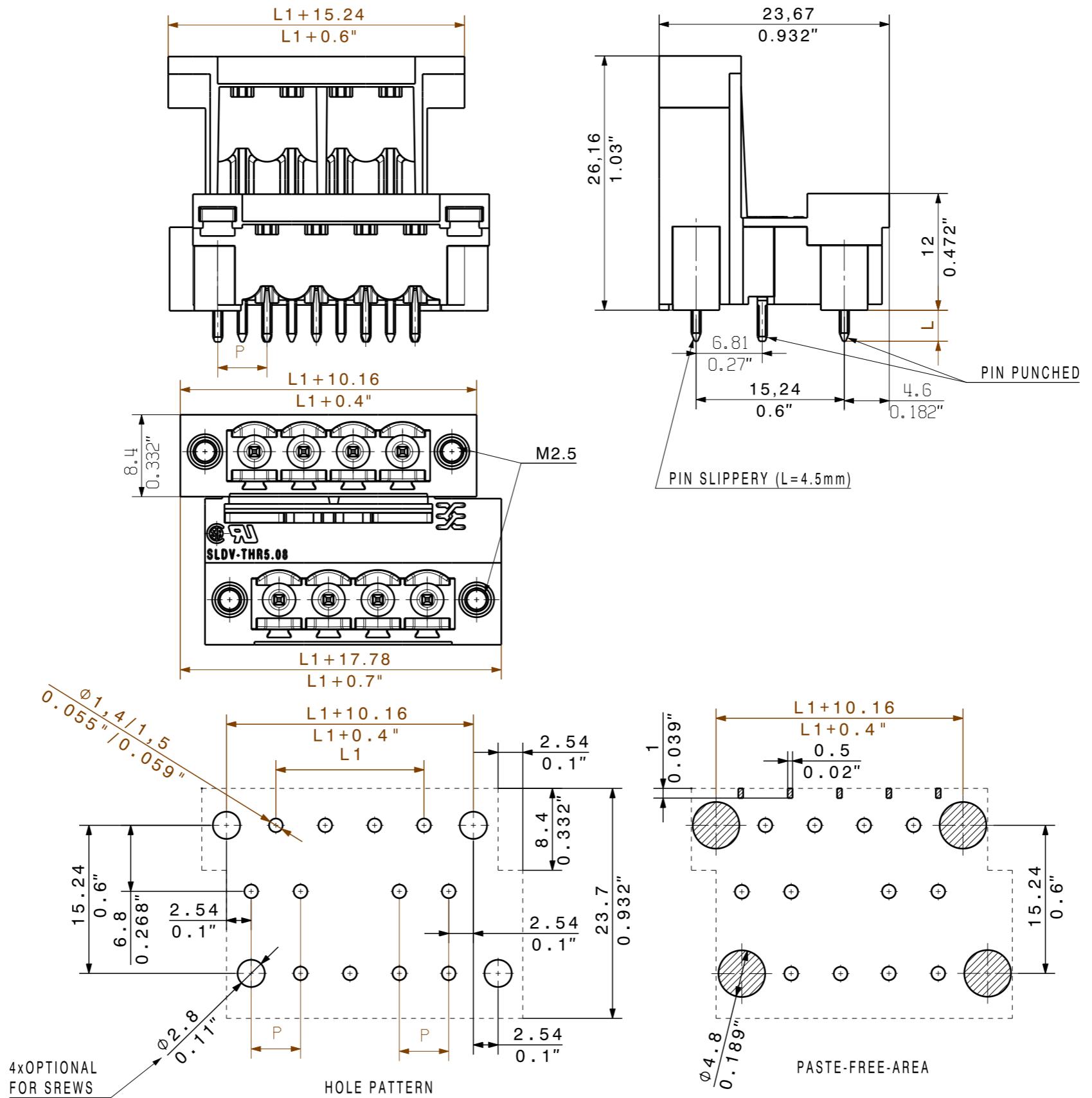
## Product benefits



## Safe power transmission Proven properties

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 Weidmueller Interface GmbH & Co. KG



For the mounting of PCBs, it should be noted that the rated data given in the catalogue relates only to the connection elements. The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmueller connectors are tested to the DIN VDE 0627 standard, and are valid for its field of application. Provided that the connectors are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

General tolerance: DIN ISO 2768-mK	91693/5 04.01.17 HELIS
	Modifica
Scale: 2:1	Drawn 22
Supersedes: .	Responsible
	Checked 10
	Approved

General tolerance  
DIN ISO 2768-mK



Modifica

very fine.

E 0627  Drawn 22

1. **Responsible**

Scale: 2:1

Supercedes:	Approved
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	48	116,84	4,60
	46	111,76	4,40
	44	106,68	4,20
	42	101,60	4,00
	40	96,52	3,80
	38	91,44	3,60
	36	86,36	3,40
	34	81,28	3,20
	32	76,20	3,00
	30	71,12	2,80
	28	66,04	2,60
	26	60,96	2,40
	24	55,88	2,20
	22	50,80	2,00
	20	45,72	1,80
	18	40,64	1,60
	16	35,56	1,40
ANZ	14	30,48	1,20
	12	25,40	1,00
	10	20,32	0,80
	8	15,24	0,60
	6	10,16	0,40
	4	5,08	0,20
	n	L1 [mm]	L1 [inch]

3 34069 0

no. Issue no.

03 of 03 sheets

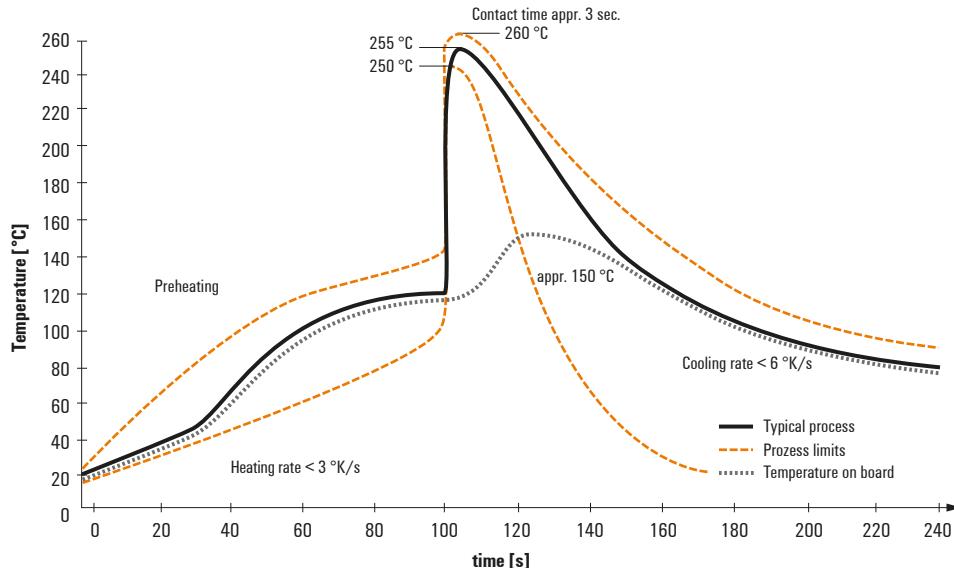
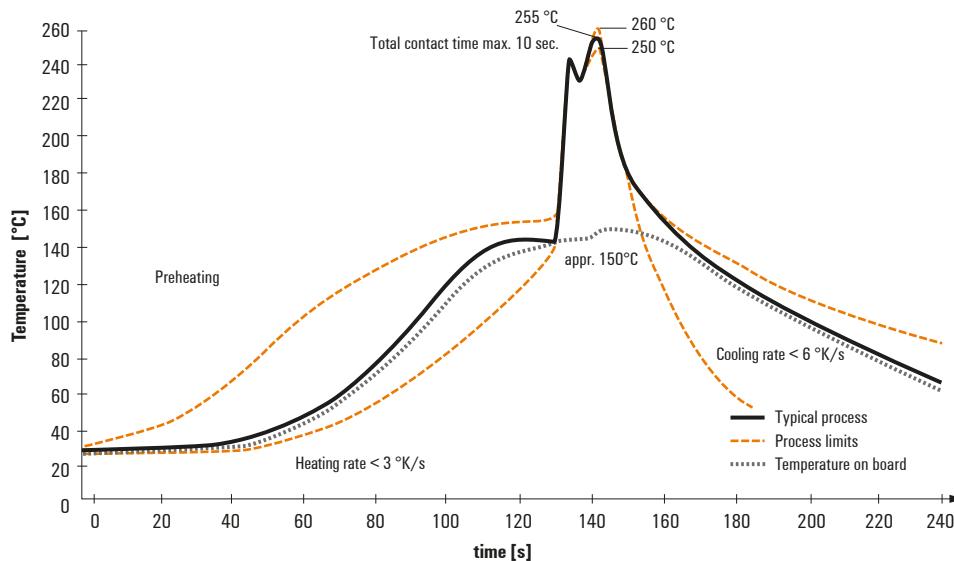
**Weidmüller** 

**SLDV-THR 5.08/../180F**  
STIFTLEISTE  
PIN HEADER

Product file: S1DV THB 5.08

## Recommended wave soldering profiles

**Weidmüller Interface GmbH & Co. KG**  
 Klingenbergsstraße 16  
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 Germany  
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**Single Wave:****Double Wave:****Wave soldering profiles**

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

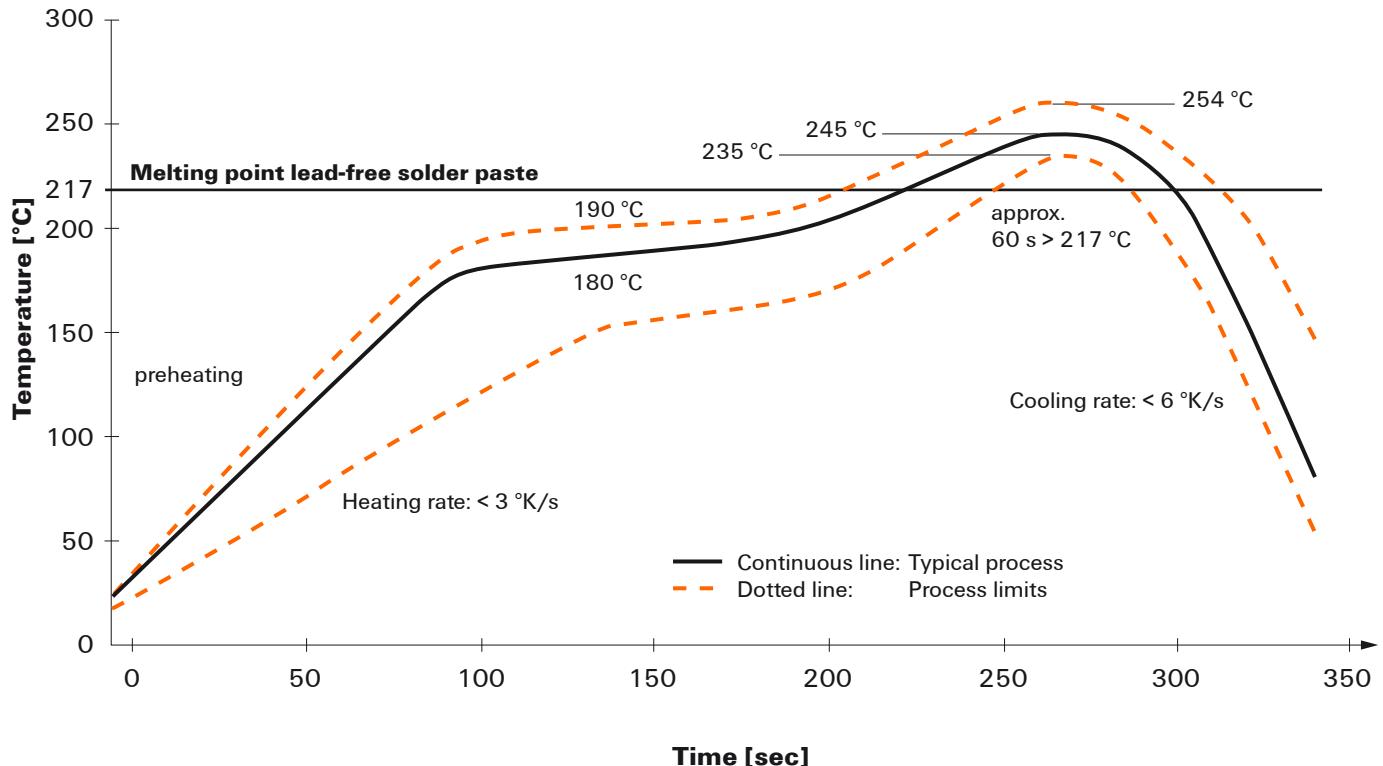
When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

## Recommended reflow soldering profile

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## Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3\text{K/s}$ . In parallel the solder paste is 'activated'. The time above melting point of  $217^\circ\text{C}$  the paste gets liquid and components and boards begin to connect. The maximum temperature of  $245^\circ\text{C}$  to  $254^\circ\text{C}$  should stay between 10 and 40 seconds. In the cooling phase at  $\geq -6\text{K/s}$  solder is cured. Board and components cool down while avoiding cold cracks.